



**DFLS1100** 

#### 1.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER **POWERDI**

# **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F</sub> max (V)	I <sub>R max</sub> (μA)
100	1	0.77	0.35

# **Features and Benefits**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current
- Lead Free Finish, RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

# **Description and Applications**

This Schottky Barrier Rectifier is designed to meet the stringent requirements of Automotive Applications. It is ideally suited for use as:

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

## **Mechanical Data**

- Case: POWERDI®123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.01 grams (Approximate)



Top View

## Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
DFLS1100-7	Commercial	POWERDI <sup>®</sup> 123	3000/Tape & Reel
DFLS1100Q-7	Automotive	POWERDI®123	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



F09 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014)M = Month (ex: 9 = September)

Date Code Key

Year	2013	20	14	2015	2016	20	17	2018	2019	20	20	2021
Code	Α	I	3	С	D		E	F	G	I	+	I
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	71	V
Forward Current rms ( $T_C = +160$ °C, $D = 0.5$ )	I <sub>F(RMS)</sub>	2	Α
Average Forward Current	I <sub>F(AV)</sub>	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	50	А
Repetitive Peak Reverse Current $t_P$ = 2 $\mu$ s, f = 1 $k$ Hz Square	I <sub>RRM</sub>	1.0	А
Repetitive Peak Avalanche Power $t_P = 1 \mu s$ , $T_J = +25$ °C	P <sub>ARM</sub>	1500	W
Non-repetitive Peak Reverse Current t <sub>P</sub> = 100µs Square	I <sub>RSM</sub>	1.0	А
Critical Rate of Rise of Reverse Voltage (Rated $V_R$ , $T_J = +25$ °C)	dV/dt	10000	V/µs

# **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering (Note 6)	$R_{ heta JS}$		7	
Thermal Resistance Junction to Ambient (Note 7) T <sub>A</sub> = +25°C	$R_{ hetaJA}$	125		°C/W
Thermal Resistance Junction to Case (Note 7) T <sub>A</sub> = +25°C	$R_{ heta JC}$	21	_	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to	+175	°C

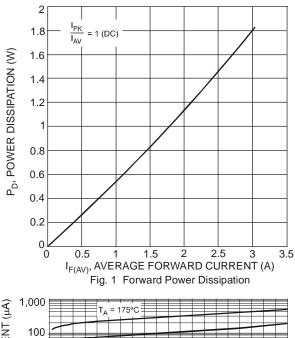
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

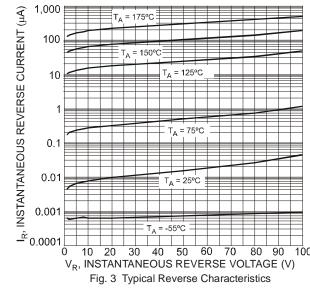
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	100	_		V	$I_R = 1mA$
			_	0.77		$I_F = 1.0A, T_A = +25^{\circ}C$
Forward Voltage			0.58	0.62		$I_F = 1.0A, T_A = +125$ °C
Forward voltage	V <sub>F</sub>	_	_	0.86	v	$I_F = 2.0A, T_A = +25^{\circ}C$
		_	0.65	0.7		I <sub>F</sub> = 2.0A, T <sub>A</sub> = +125°C
		_	_	0.10	μΑ	$V_R = 50V, T_A = +25^{\circ}C$
		_	_	3	μΑ	$V_R = 50V, T_A = +65^{\circ}C$
Leakage Current (Note 8)	I <sub>R</sub>	_	_	15	μΑ	$V_R = 50V, T_A = +85^{\circ}C$
		_	_	0.35	μΑ	$V_R = 100V, T_A = +25^{\circ}C$
		_	_	0.35	mA	$V_R = 100V, T_A = +125^{\circ}C$
Total Capacitance	C <sub>T</sub>	_	36	_	pF	$V_R = 5V_{DC}$ , $f = 1MHz$

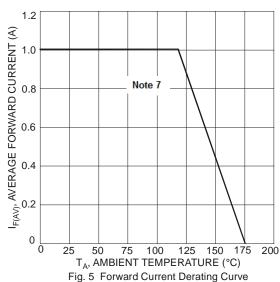
Notes:

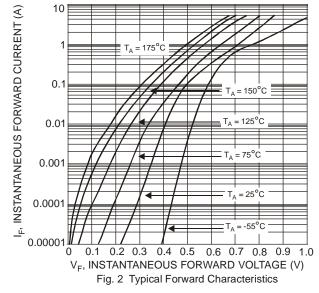
- 6. Theoretical R<sub>BJS</sub> calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
- 7. Part mounted on FR-4 board with 2oz., minimum recommended copper pad layout, which can be found on our website at http://www.diodes.com.
- 8. Short duration pulse test used to minimize self-heating effect.

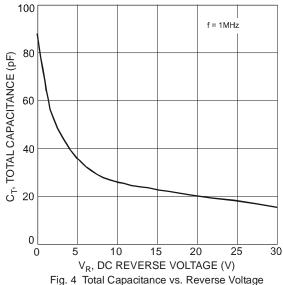












100,000

T<sub>J</sub> = 25°C

1,000

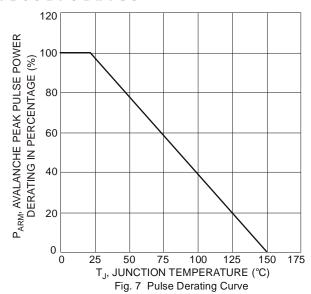
1,000

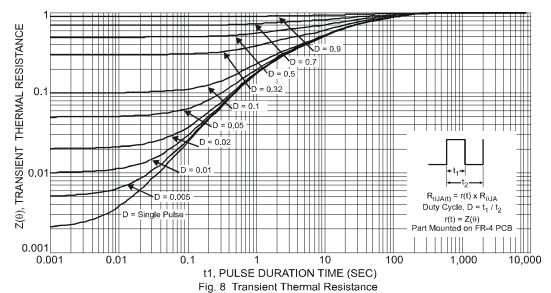
T<sub>J</sub> = 25°C

1,000

T<sub>P</sub>, PULSE DURATION(µs)





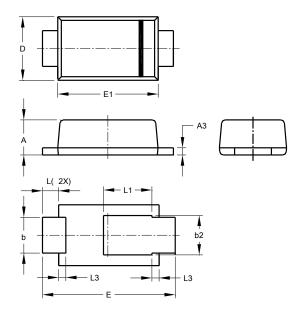




# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### POWERDI®123

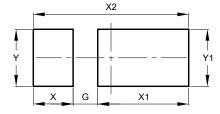


POWERDI <sup>®</sup> 123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
A3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### POWERDI<sup>®</sup>123



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Υ	1.50
Y1	1.50



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